COMPLIANT

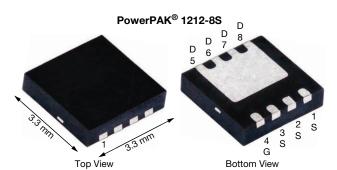
HALOGEN

**FREE** 



Vishay Siliconix

# N-Channel 80 V (D-S) MOSFET



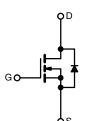
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	80				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.0089				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 7.5 \text{ V}$	0.0105				
Q <sub>g</sub> typ. (nC)	15				
I <sub>D</sub> (A)	54.7				
Configuration	Single				

#### **FEATURES**

- TrenchFET® Gen IV power MOSFET
- Very low R<sub>DS</sub> x Q<sub>g</sub> figure-of-merit (FOM)
- Tuned for the lowest R<sub>DS</sub> x Q<sub>oss</sub> FOM
- 100 % R<sub>a</sub> and UIS tested
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **APPLICATIONS**

- Synchronous rectification
- · Primary side switch
- DC/DC converter
- Solar micro inverter
- · Motor drive switch
- · Battery and load switch
- Industrial



N-Channel MOSFET

PowerPAK 1212-8S
SiSS30ADN-T1-GE3

<b>ABSOLUTE MAXIMUM RATING</b>	<b>iS</b> (T <sub>A</sub> = 25 °C, u	ınless otherv	vise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		$V_{DS}$	80	V	
Gate-source voltage		$V_{GS}$	± 20	V	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		54.7		
	T <sub>C</sub> = 70 °C	1 .	43.5		
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	15.9 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		12.5 <sup>b, c</sup>		
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	120	Α	
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		51.8		
	T <sub>A</sub> = 25 °C	l <sub>S</sub>	4.3 <sup>b, c</sup>		
Single pulse avalanche current		I <sub>AS</sub>	20		
Single pulse avalanche energy  L = 0.1 mH		E <sub>AS</sub>	20	mJ	
	T <sub>C</sub> = 25 °C		57		
Maximum power dissipation	T <sub>C</sub> = 70 °C		36	W	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	4.8 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C	ĺ	3 b, c		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150		
Soldering recommendations (peak temperature) c			260	°C	

THERMAL RESISTANCE RATING	S				
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient <sup>b</sup>	t ≤ 10 s	R <sub>thJA</sub>	21	26	°C/W
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	1.7	2.2	C/VV

#### Notes

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- t = 10 s
- See solder profile (<a href="https://www.vishay.com/doc?73257">www.vishay.com/doc?73257</a>). The PowerPAK 1212-8S is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- Maximum under steady state conditions is 70 °C/W
- g.  $T_C = 25$  °C



# Vishay Siliconix

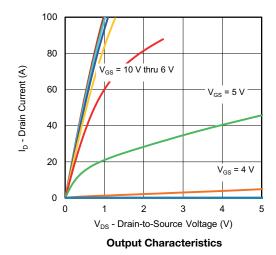
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	80	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 10 mA	-	62	-	1400
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_{J}$	I <sub>D</sub> = 250 μA	-	-6.9	-	mV/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2	-	3.5	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	100	nA
	I <sub>DSS</sub>	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V	-	-	1	μΑ
Zero gate voltage drain current		V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C	-	-	15	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	40	_	-	Α
	_(::,)	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A	-	0.0074	0.0089	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 7.5 V, I <sub>D</sub> = 10 A	-	0.0086	0.0105	Ω
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 10 A	-	28	-	S
Dynamic <sup>b</sup>					l	
Input capacitance	C <sub>iss</sub>		-	1295	-	
Output capacitance	C <sub>oss</sub>	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	204	-	pF
Reverse transfer capacitance	C <sub>rss</sub>		-	4	-	
Total mate aboves	0	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A	-	19.5	30	
Total gate charge	Q <sub>g</sub>		-	15	23	
Gate-source charge	Q <sub>gs</sub>	$V_{DS}$ = 40 V, $V_{GS}$ = 7.5 V, $I_{D}$ =10 A	-	6.2	-	nC
Gate-drain charge	$Q_{gd}$		-	3.4	-	
Output charge	Q <sub>oss</sub>	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$	-	26.5	-	
Gate resistance	$R_g$	f = 1 MHz	0.3	0.80	1.5	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	12	24	
Rise time	t <sub>r</sub>	$V_{DD}$ = 40 V, $R_L$ = 4 $\Omega,I_D\cong$ 10 A,	-	7	14	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	19	38	
Fall time	t <sub>f</sub>		-	7	14	ns
Turn-on delay time	t <sub>d(on)</sub>		-	14	28	1.0
Rise time	t <sub>r</sub>	$V_{DD} = 40 \text{ V}, R_L = 4 \Omega, I_D \cong 10 \text{ A},$	-	7	14	- -
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 7.5 \text{ V}, R_g = 1 \Omega$	-	18	36	
Fall time	t <sub>f</sub>		-	7	14	
Drain-Source Body Diode Characteristi	T T			l	1	T
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	51.8	Α
Pulse diode forward current	I <sub>SM</sub>		-	-	120	
Body diode voltage	V <sub>SD</sub>	$I_S = 5 A, V_{GS} = 0 V$	-	0.77	1.1	V
Body diode reverse recovery time	t <sub>rr</sub>		-	33	66	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = 10 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s,}$	-	33	66	nC
Reverse recovery fall time	t <sub>a</sub>	$T_J = 25  ^{\circ}C$	-	22	-	ns
Reverse recovery rise time	t <sub>b</sub>		-	11	-	

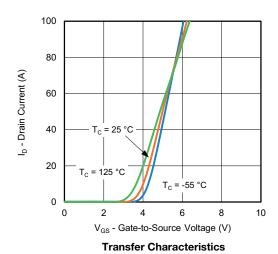
#### Notes

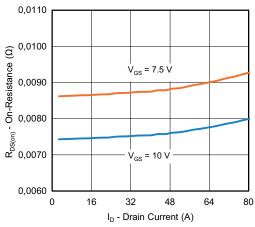
- a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

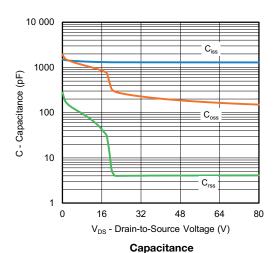
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



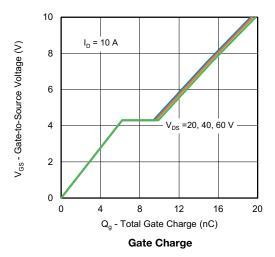


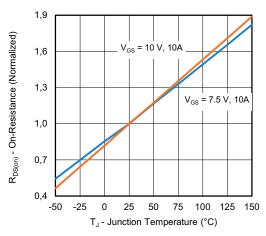






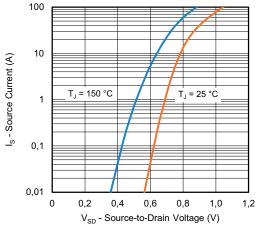
On-Resistance vs. Drain Current and Gate Voltage



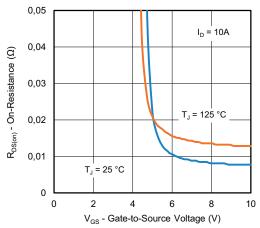


On-Resistance vs. Junction Temperature

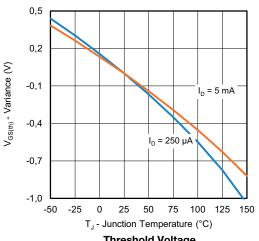




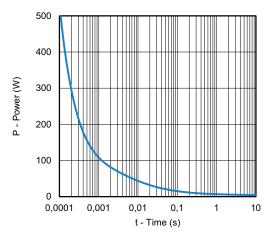
#### Source-Drain Diode Forward Voltage



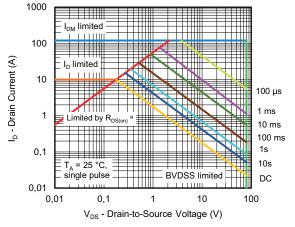
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



Single Pulse Power, Junction-to-Ambient

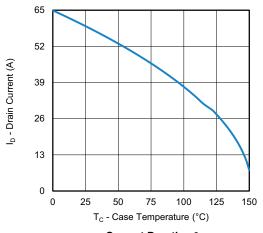


Safe Operating Area, Junction-to-Ambient

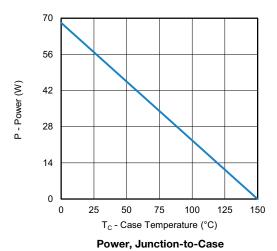
#### Note

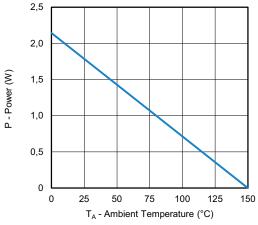
a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

S20-0380-Rev. A, 25-May-2020



### Current Derating a



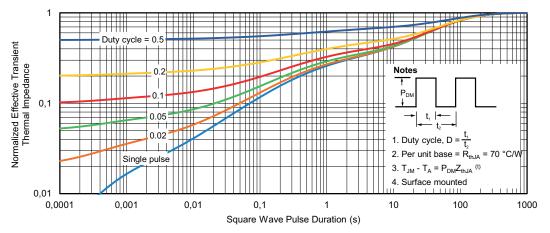


Power, Junction-to-Ambient

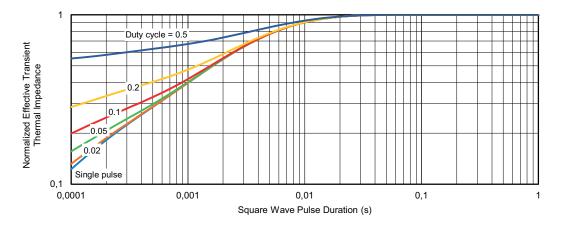
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient

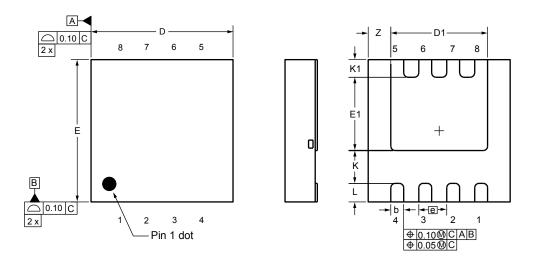


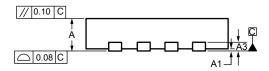
Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?77571">www.vishay.com/ppg?77571</a>.



# Case Outline for PowerPAK® 1212-8S





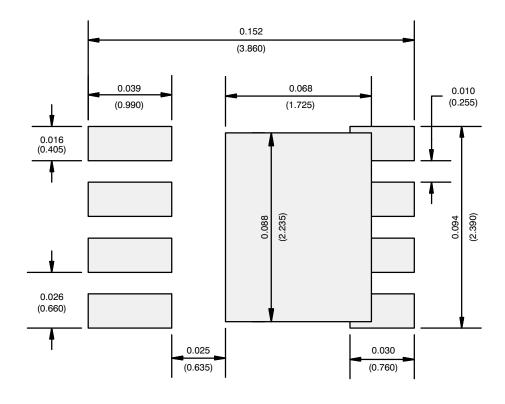
DIM.	MILLIMETERS			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	0.67	0.75	0.83	0.026	0.030	0.033	
A1	0.00	-	0.05	0.000	-	0.002	
A3		0.20 ref.			0.008 ref		
b	0.25	0.30	0.35	0.010	0.012	0.014	
D	3.20	3.30	3.40	0.126	0.130	0.134	
D1	2.15	2.25	2.35	0.085	0.089	0.093	
E	3.20	3.30	3.40	0.126	0.130	0.134	
E1	1.60	1.70	1.80	0.063	0.067	0.071	
е		0.65 bsc.			0.026 bsc.		
K		0.76 ref.			0.030 ref.		
K1	0.41 ref.			0.41 ref. 0.016 ref.			
L	0.33	0.43	0.53	0.013	0.017	0.021	
Z	0.525 ref.				0.021 ref.		

ECN: C20-0862-Rev. B, 20-Jul-2020

DWG: 6008



## RECOMMENDED MINIMUM PADS FOR PowerPAK® 1212-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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